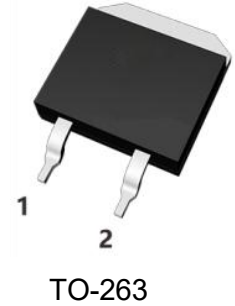
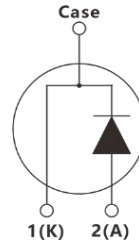


Silicon Carbide Schottky Diode

Parameter	Value	Unit
V_{RRM}	650	V
I_F	8	A
Q_C	28	nC



Features

- Zero reverse recovery current
- Zero forward recovery voltage
- Temperature independent switching behavior
- High temperature operation
- High frequency operation

Applications

- Boost Converter
- Power Factor Correction
- Switched-Mode Power Supply
- Uninterruptible Power Supply

Maximum Ratings (at $T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	650	V
Surge Peak Reverse Voltage	V_{RSM}	650	V
Continuous Forward Current $T_C = 25^\circ\text{C}$ $T_C = 135^\circ\text{C}$ $T_C = 157.5^\circ\text{C}$	I_F	29.7 13.7 8	A
Repetitive Peak Forward Surge Current $T_C = 25^\circ\text{C}$, $t_p = 10\text{ms}$, Half Sine Pulse, $D=0.1, 1000\text{Cycle}$	I_{FRM}	40	A
Non-Repetitive Forward Surge Current $T_C = 25^\circ\text{C}$, $t_p = 10\text{ms}$, Half Sine Pulse	I_{FSM}	80	A
i^2t Value $T_C = 25^\circ\text{C}$, $t_p = 10\text{ms}$, Half Sine Pulse	$\int i^2 dt$	32	A^2s
Power dissipation $T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$	P_{tot}	106 46	W
Operating junction Range	T_J	-55 to +175	$^\circ\text{C}$
Storage temperature Range	T_{stg}	-55 to +175	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ.	Unit
Thermal resistance, junction – case.	R_{thJC}	1.42	°C/W

Electrical Characteristics(at $T_J=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
DC Blocking Voltage	V_{DC}		650			V
Instantaneous forward voltage per leg	V_F	$I_F=8\text{A}$ $T_J=25^{\circ}\text{C}$ $T_J=175^{\circ}\text{C}$		1.3 1.56	1.7 1.8	V
Reverse current per leg	I_R	$V_R=650\text{V}$ $T_J=25^{\circ}\text{C}$ $T_J=175^{\circ}\text{C}$		0.2 2.0	50 100	uA
Total Capacitance	C	$f=1\text{MHZ}$ $V_R=0\text{V}$ $V_R=200\text{V}$ $V_R=400\text{V}$		536 55 53		pF
Total Capacitive Charge	Q_C	$V_R=400\text{V}$ $T_J=25^{\circ}\text{C}$		28		nC
Capacitance Stored Energy	E_C	$V_R=400\text{V}$		6.8		uJ

Typical Characteristics

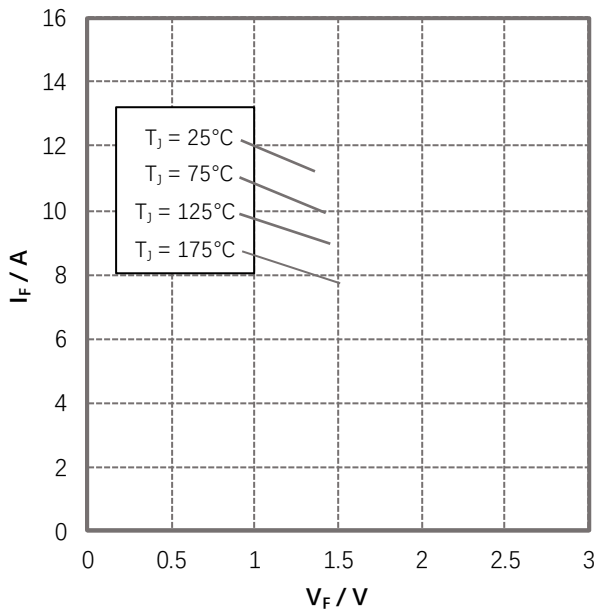


Figure 1. Forward Characteristics

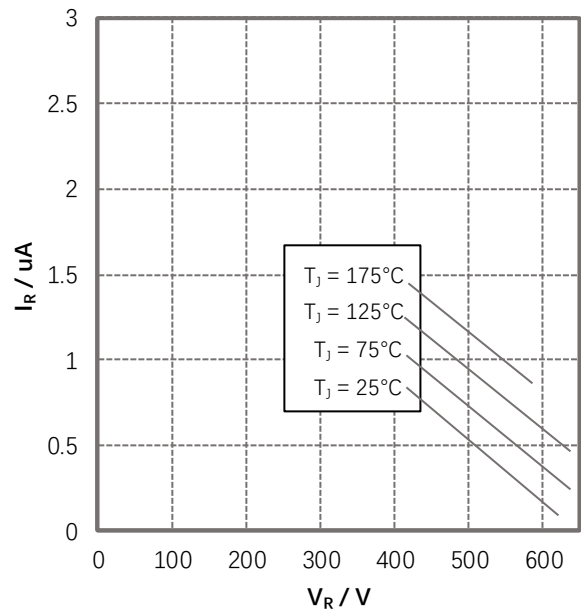


Figure 2. Reverse Characteristics

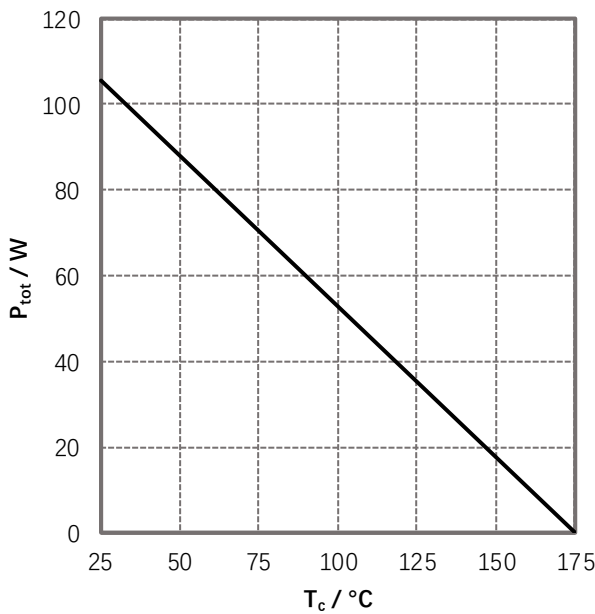


Figure 3. Power Derating

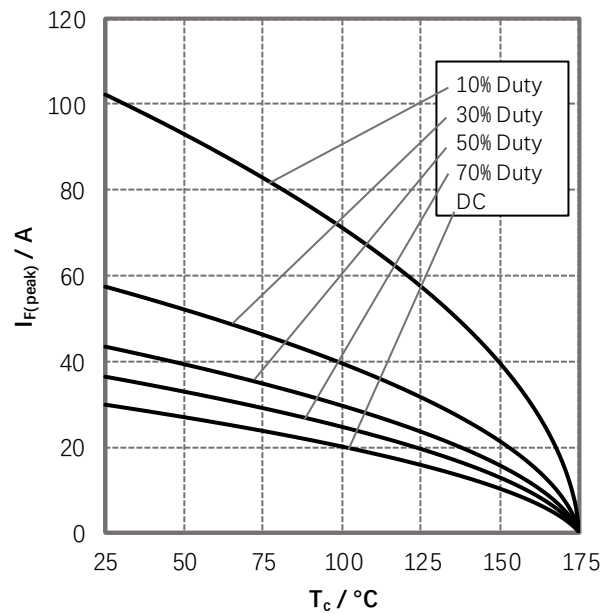


Figure 4. Current Derating
Valid for switching of above 20kHz,
excluding D.C. curve

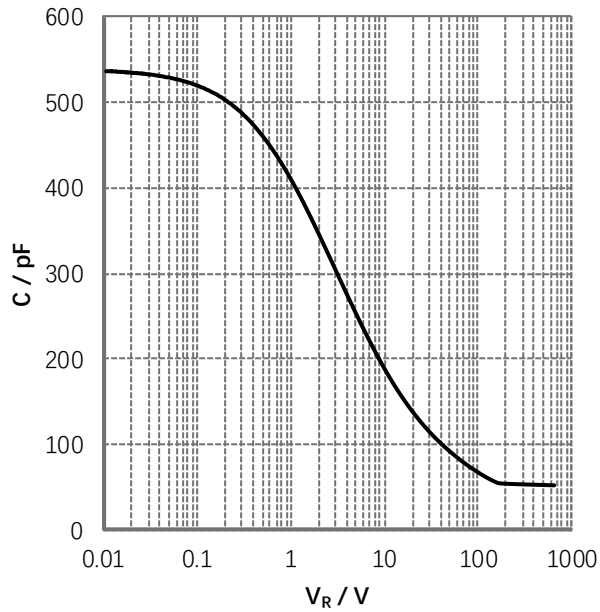


Figure 5. Capacitance vs. Reverse Voltage

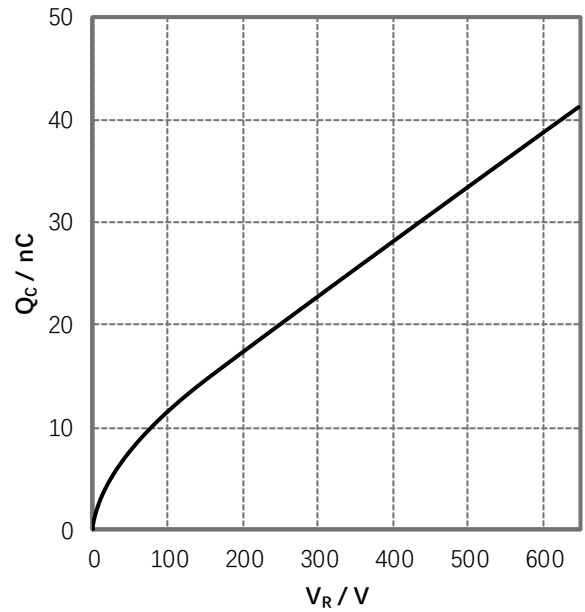


Figure 6. Reverse Charge vs. Reverse Voltage

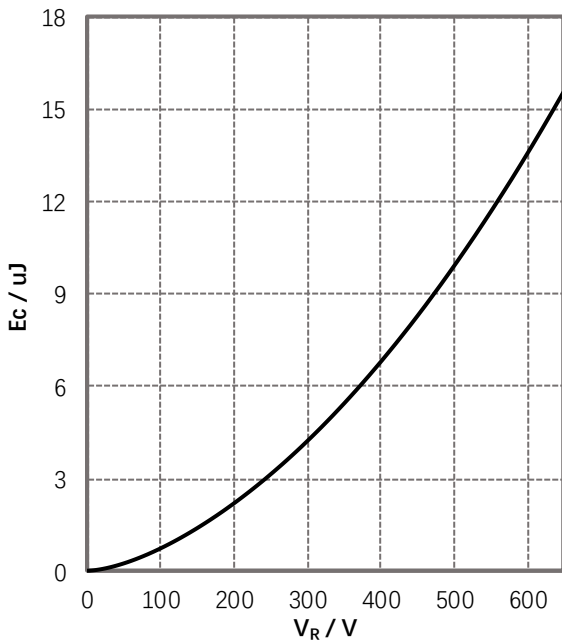


Figure 7. Capacitance Stored Energy

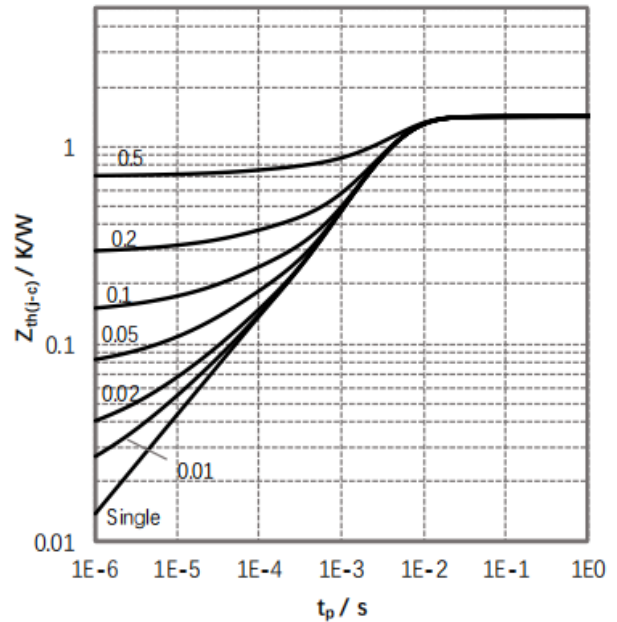
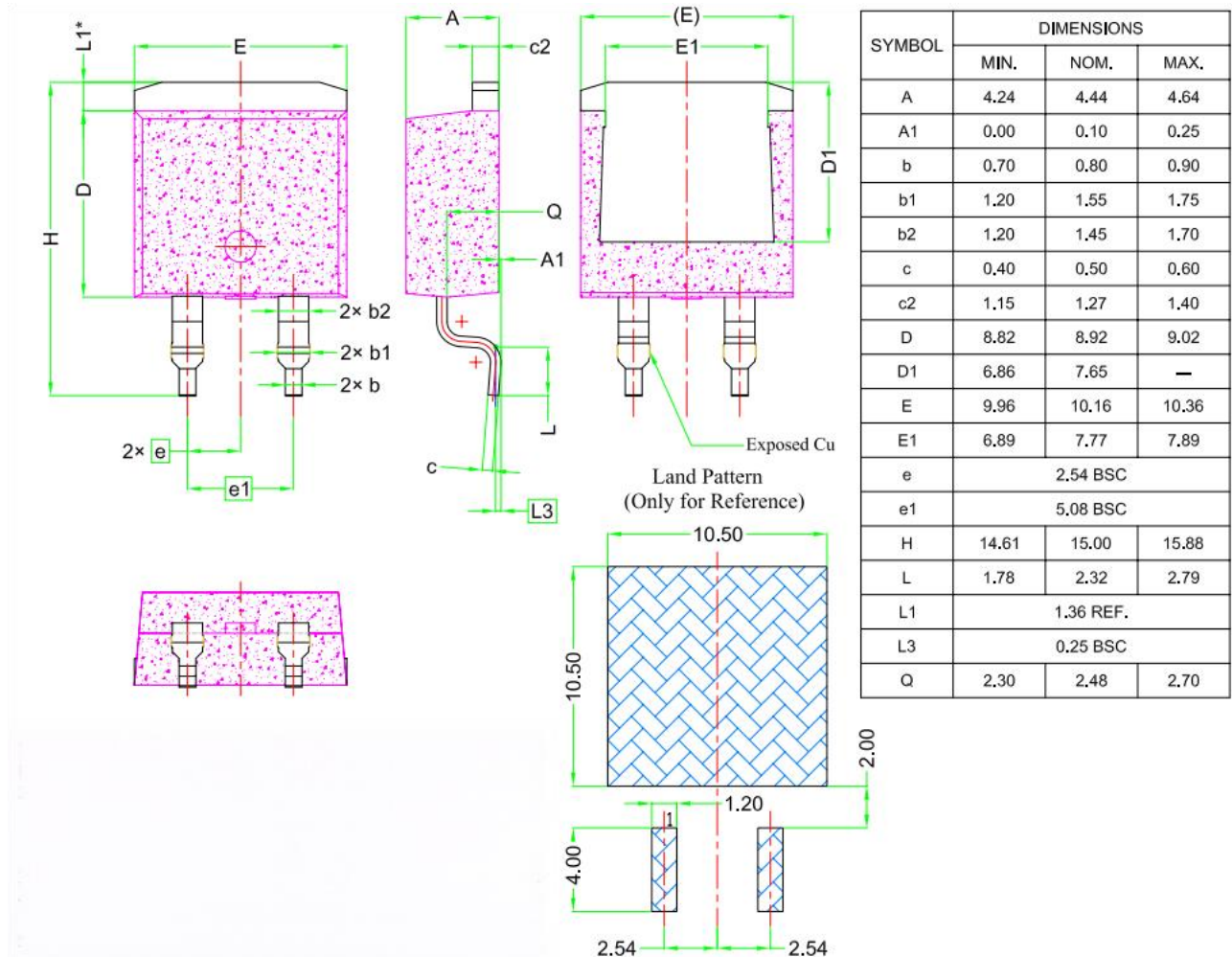


Figure 8. Transient Thermal Impedance

Package Outlines(Unit:mm)

TO-263



*Important Usage Information and Disclaimer

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